PC	N Number:	201907120	000	PCN Da	ate:	July	18, 20)19	
Title: Datasheet for LM5575-Q1									
Cu	stomer Contact:	PCN Manag	<u>er</u>			De	pt:	Quality Services	
Ch	ange Type:								
	Assembly Site			Design				r Bump Site	
Assembly Process			Data Sheet		ļЦ.		r Bump Material		
Assembly Materials			Part number chang	ge	╞┝┥		r Bump Process		
⊢	Mechanical Specification		\square	Test Site Test Process			Wafer Fab Site Wafer Fab Materials		
Packing/Shipping/Labeling			Test Process		╞╞┽	Wafer Fab Process			
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.									
					ç	SNOSB2	23F-OCTO	BER 2008-REVISED JULY 2019	
Changes from Revision E (February 2019) to Revision F Page									
Added Grade 0 information to Features									
	Added Grade 1 and G	ade 0 sentence to	end	of Description				1	
	e datasheet numbe evice Family	r will be chan	ging	g. Change From:			Chang	je To:	
Lľ	LM5575-Q1			SNOSB23E			SNOSB23F		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/LM5575-Q1									
Re	ason for Change								
То	accurately reflect	device charact	eris	tics.					
An	ticipated impact	on Fit, Form	, Fι	inction, Quality o	r Relia	bility	y (pos	itive / negative):	
No								ere are no changes	
		identificatio	on r	esulting from this	s PCN:				
Changes to product identification resulting from this PCN: None.									
Pre	oduct Affected:								
	/15575Q0MH/NOPB	LM5575Q	OMF	IX/NOPB LM55	75QMH	/NOP	В	LM5575QMHX/NOPB	
	· questions regardi al Field Sales Repr		e-i	mails can be sent to	o the co	ntac	ts shov	vn below or your	

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN ww admin team@list.ti.com

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